

Description

The SGM809 is a general-purpose voltage detector which only consume about 5uA at 3.6V, which can be widely used in all electronic system to either monitor a battery voltage or generate a power-on reset signal. It can work under the voltage ranging from 1V to 6V.

SGM809 employs a low voltage reference, low offset comparator,timer and push-pull output stage. Its push-pull output is pushed high after input voltage is greater than the internal setting level for 240ms. The SGM809 is available in SOT-23 package.

Features

Wide operation range:1-6V Voltage detecting level setting range:2.3-5V SOT-23 package Detection delay time: 240ms Reset pin output kept low when input voltage < 1V 4kV ESD

Applications

Battery voltage monitor Power-on reset Set-top-box Voltage level trigger Press button debouncing Portable devices

Package Marking and Ordering Information

Part No	Voltage Detecting Level	Package	Tape & Reel	
SGM809-ZXN3L/TR	2.32V			
SGM809-RXN3L/TR	2.63V		3K/Reel	
SGM809-SXN3L/TR	2.93V			
SGM809-TXN3L/TR	3.08V	SOT-23		
SGM809-JXN3L/TR	4.00V			
SGM809-MXN3L/TR	4.38V			
SGM809-LXN3L/TR	4.63V			



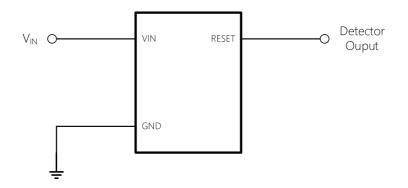
Symbol	Parameter	Limit	Unit
Vin		-0.3 to 8	V
VRESET		-0.3 to V _N +0.3	V
	Continuous Power Dissipation	0.3	W
TJ	Junction Temperature	-40 to 125	°C
	Lead Temperature	260	°C
Тята	Storage Temperature	-55 To 150	°C
Reja	Thermal Resistance, Junction-to-Ambient (Note 2)	280	°C/W
Rejc	Thermal Resistance, Junction-to-Ambient (Note 2)	90	°C/W

Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Notes:

- (1) Exceeding these ratings may damage the device.
- (2) The maximum allowable power dissipation is a function of the maximum junction temperature $T_J(MAX)$, the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A . The maximum allowable continuous power dissipation at any ambient temperature is calculated by $P_D(MAX)=(T_J(MAX)-T_A)/\theta_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- (3) Measured on JESD51-7, 4-layer PCB.

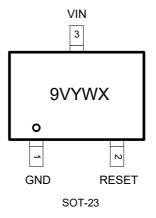
Typical Application



Detector output remains low if V_{IN} is below detecting level, and jumps to high if VIN is above detecting level for 240ms



Pin Assignment



The package of SGM809 is SOT23, withpin assignment shown in following table:

Pin No	Name	Description	
1	GND	Ground	
2	VIN	The power input node as well as the voltage node to be detected	
3	RESET	The push pull output node, pulled low when $V_{\mbox{\scriptsize IN}}$ is lower than detect	
		level and pushed high when $V_{\mbox{\scriptsize IN}}$ is higher than detect level for 240ms	



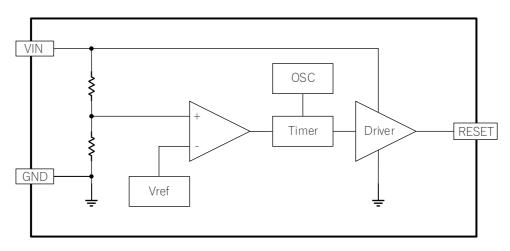
Parameter	Conditions	Min	Тур	Max	Units
Input voltage range, V _{IN}		1		6	V
	V _{IN} = 3.6V, T _A =25°	3	5	10	μA
Quiescent current, I_{Q}	$\oint_{IN} = 3.6V, T_{A} = -40^{\circ}$	2	3.5	10	μA
	$\oint_{IN} = 3.6V, T_A = 125^{\circ}$	4	6.3	15	μA
	$\Theta_{\text{DET}} = 2.32 \text{V}$	2.262	2.32	2.378	V
	V _{DET} = 2.63V	2.564	2.63	2.696	V
	V _{DET} = 2.93V	2.857	2.93	3.003	V
Detecting voltage level, $V_{\mbox{\scriptsize DET}}$	V _{DET} = 3.08V	3.003	3.08	3.157	V
	V _{DET} = 4.00V	3.92	4.00	4.08	V
	V _{DET} = 4.38V	4.292	4.38	4.468	V
	V _{DET} = 4.63V	4.537	4.63	4.723	V
Delay time	$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$	150	240	560	ms
Reset falling delay	t falling delay VIN falling below V _{DET}		2	50	μs
Reset output low voltage, V _{OL} I _{SINK} = 1.2mA, V _{IN} =2V		0	0.03	0.3	V
Reset output high voltage, V_{OH}	I _{SOURCE} = 1.2mA, V _{IN} =3V	V _{IN} -0.3	V _{IN} -0.05	V _{IN}	V

Electrical Characteristics (T_A=25°C unless otherwise noted)

Function Descriptions

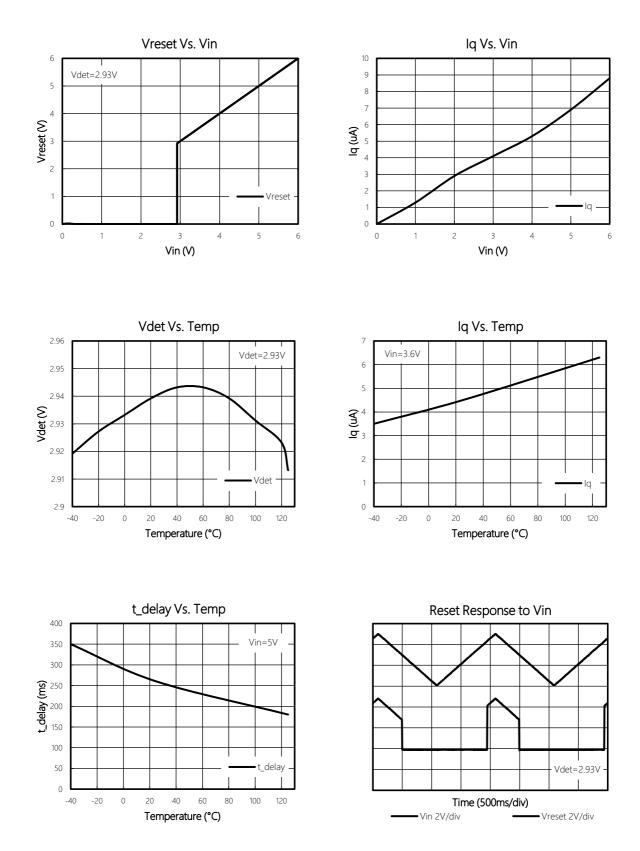
The SGM809 is a general-purpose voltage detector. It can work from 1V to 6V while consuming about 5uA at 3.6V.SGM809 keeps monitoring its VIN voltage, and RESET will jump high if VIN voltage is higher than detecting level V_{DET} for 240ms. Given all these features, SGM809 is suitable for the applications like battery voltage monitoring, power-on reset, voltage SGM809 employs a low voltage reference, low offset comparator, timer and push-pull output stage. Its push-pull output is comparison and even press button debouncing.

Function Diagram



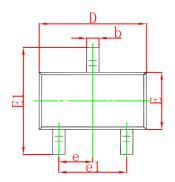


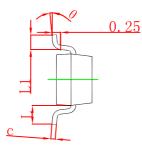
Typical Characteristics

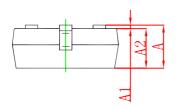




SOT-23 Package Outline Dimensions

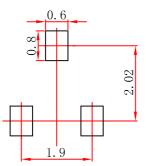






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
e	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0 REF 0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note: 1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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